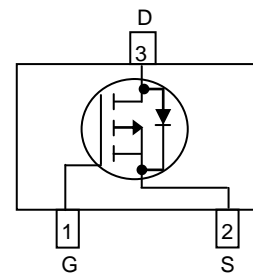


WPM3401
Single P-Channel, -30V, -4.6A, Power MOSFET
www.sh-willsemi.com

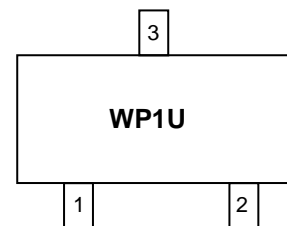
| V_{DS} (V) | Max $R_{DS(on)}$ (m Ω) |
|--------------|--------------------------------|
| -30 | 53 @ $V_{GS} = -10V$ |
| | 56 @ $V_{GS} = -4.5V$ |


SOT-23-3L
Descriptions

The WPM3401 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application, notebook computer power management and other battery powered circuits where high-side switching.


Pin configuration (Top view)
Features

- Trench Technology
- Supper high density cell design
- Excellent ON resistance for higher DC current
- Small package SOT-23-3L



WP1= Specific Device Code

U = Date Code

Marking
Applications

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch

Order information

| Device | Package | Shipping |
|--------------|-----------|----------------|
| WPM3401-3/TR | SOT-23-3L | 3000/Reel&Tape |

Absolute Maximum ratings

| Parameter | | Symbol | 10 s | Steady State | Unit |
|--|--------------------------|-----------|------------|--------------|--------------------|
| Drain-Source Voltage | | V_{DS} | -30 | | V |
| Gate-Source Voltage | | V_{GS} | ± 12 | | |
| Continuous Drain Current ^a | $T_A=25^{\circ}\text{C}$ | I_D | -5.5 | -4.6 | A |
| | $T_A=70^{\circ}\text{C}$ | | -4.4 | -3.6 | |
| Maximum Power Dissipation ^a | $T_A=25^{\circ}\text{C}$ | P_D | 1.7 | 1.3 | W |
| | $T_A=70^{\circ}\text{C}$ | | 1.1 | 0.8 | |
| Continuous Drain Current ^b | $T_A=25^{\circ}\text{C}$ | I_D | -5.0 | -4.2 | A |
| | $T_A=70^{\circ}\text{C}$ | | -4.0 | -3.4 | |
| Maximum Power Dissipation ^b | $T_A=25^{\circ}\text{C}$ | P_D | 1.4 | 1.0 | W |
| | $T_A=70^{\circ}\text{C}$ | | 0.9 | 0.6 | |
| Pulsed Drain Current ^c | | I_{DM} | -20 | | A |
| Operating Junction Temperature | | T_J | 150 | | $^{\circ}\text{C}$ |
| Lead Temperature | | T_L | 260 | | $^{\circ}\text{C}$ |
| Storage Temperature Range | | T_{stg} | -55 to 150 | | $^{\circ}\text{C}$ |

Thermal resistance ratings

| Parameter | | Symbol | Typical | Maximum | Unit |
|---|-----------------------|-----------------|---------|---------|----------------------|
| Junction-to-Ambient Thermal Resistance ^a | $t \leq 10 \text{ s}$ | $R_{\theta JA}$ | 70 | 90 | $^{\circ}\text{C/W}$ |
| | Steady State | | 95 | 125 | |
| Junction-to-Ambient Thermal Resistance ^b | $t \leq 10 \text{ s}$ | $R_{\theta JA}$ | 85 | 105 | |
| | Steady State | | 120 | 150 | |
| Junction-to-Case Thermal Resistance | | $R_{\theta JC}$ | 40 | 60 | |

a Surface mounted on FR-4 Board using 1 square inch pad size, 1oz copper

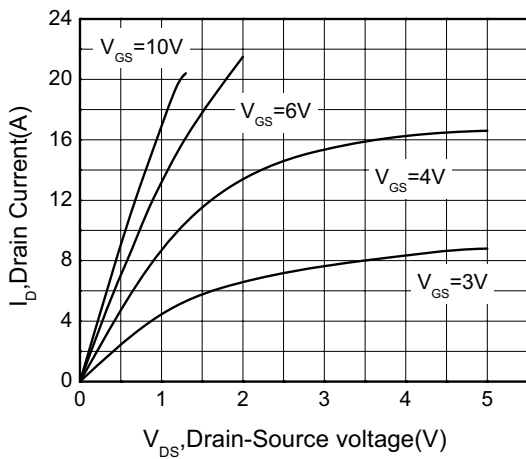
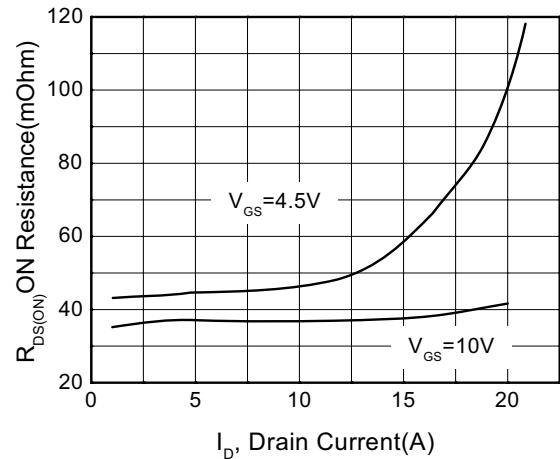
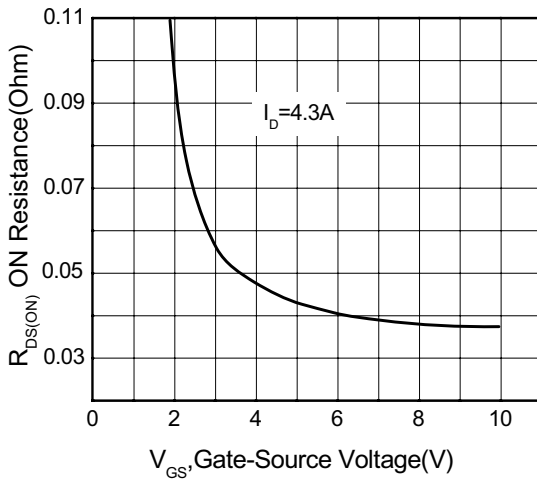
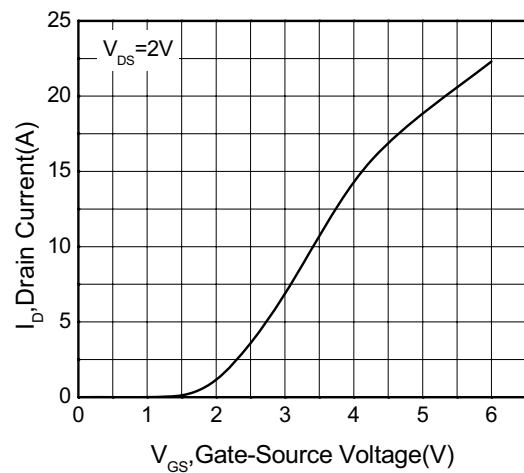
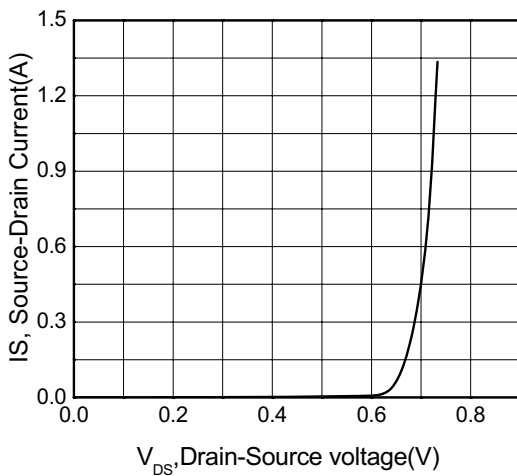
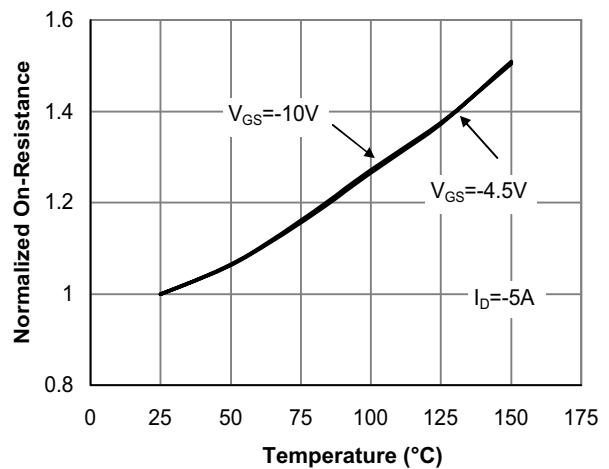
b Surface mounted on FR-4 board using minimum pad size, 1oz copper

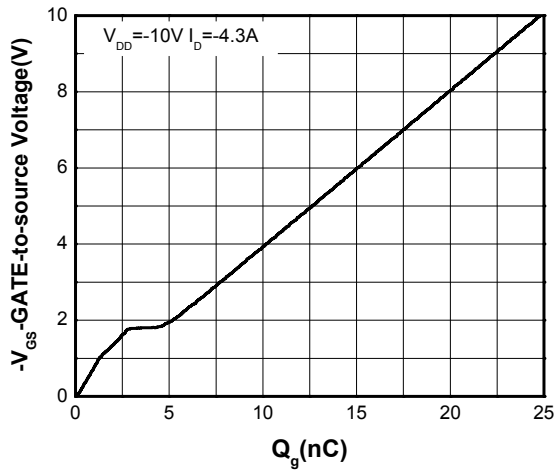
c Pulse width < 380 μs , Duty Cycle < 2%

d Maximum junction temperature $T_J=150^{\circ}\text{C}$.

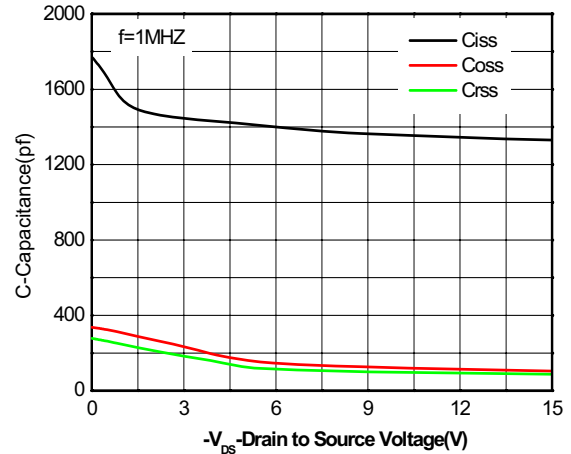
Electronics Characteristics (Ta=25°C, unless otherwise noted)

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|--|--------------|--|------|-------|-----------|------|
| OFF CHARACTERISTICS | | | | | | |
| Drain-to-Source Breakdown Voltage | BV_{DSS} | $V_{GS} = 0\text{ V}, I_D = -250\mu\text{A}$ | -30 | | | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = -24\text{ V}, V_{GS} = 0\text{ V}$ | | | -1 | uA |
| | | $V_{DS} = -24\text{ V}, V_{GS} = 0\text{ V}, T_J = 85^\circ\text{C}$ | | | -5 | |
| Gate-to-source Leakage Current | I_{GSS} | $V_{DS} = 0\text{ V}, V_{GS} = \pm 12\text{ V}$ | | | ± 100 | nA |
| ON CHARACTERISTICS | | | | | | |
| Gate Threshold Voltage | $V_{GS(TH)}$ | $V_{GS} = V_{DS}, I_D = -250\mu\text{A}$ | -0.5 | -1.0 | -1.5 | V |
| On State Drain Current (Pulse) ^{b, c} | $I_{D(on)}$ | $V_{DS} = -5\text{ V}, V_{GS} = -4.5\text{ V}$ | -10 | | | A |
| Drain-to-source On-resistance ^{b, c} | $R_{DS(on)}$ | $V_{GS} = -10\text{ V}, I_D = -4.3\text{ A}$ | | 38 | 53 | mΩ |
| | | $V_{GS} = -4.5\text{ V}, I_D = -3.5\text{ A}$ | | 43 | 56 | |
| BODY DIODE CHARACTERISTICS | | | | | | |
| Forward Voltage | V_{SD} | $V_{GS} = 0\text{ V}, I_S = -1.0\text{ A}$ | | -0.75 | -1.5 | V |
| Forward Transconductance | G_{FS} | $V_{DS} = -15\text{ V}, I_D = -4.3\text{ A}$ | | 13 | | s |
| CAPACITANCES, CHARGES | | | | | | |
| Input Capacitance | C_{ISS} | $V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz},$ $V_{DS} = -15\text{ V}$ | | 1250 | | pF |
| Output Capacitance | C_{OSS} | | | 106 | | |
| Reverse Transfer Capacitance | C_{RSS} | | | 90 | | |
| Total Gate Charge | $Q_{G(TOT)}$ | $V_{GS} = -10\text{ V},$ $V_{DD} = -10\text{ V},$ $I_D = -4.3\text{ A}$ | | 24.8 | | nC |
| Threshold Gate Charge | $Q_{G(TH)}$ | | | 1.3 | | |
| Gate-to-Source Charge | Q_{GS} | | | 2.2 | | |
| Gate-to-Drain Charge | Q_{GD} | | | 1.8 | | |
| SWITCHING CHARACTERISTICS | | | | | | |
| Turn-On Delay Time | $t_d(ON)$ | $V_{GEN} = -10\text{ V}, V_{DD} = -15\text{ V},$ $I_D = -1.0\text{ A}, R_G = 6\Omega, R_L = 15\Omega$ | | 10 | | ns |
| Rise Time | t_r | | | 18 | | |
| Turn-Off Delay Time | $t_d(OFF)$ | | | 60 | | |
| Fall Time | t_f | | | 9 | | |

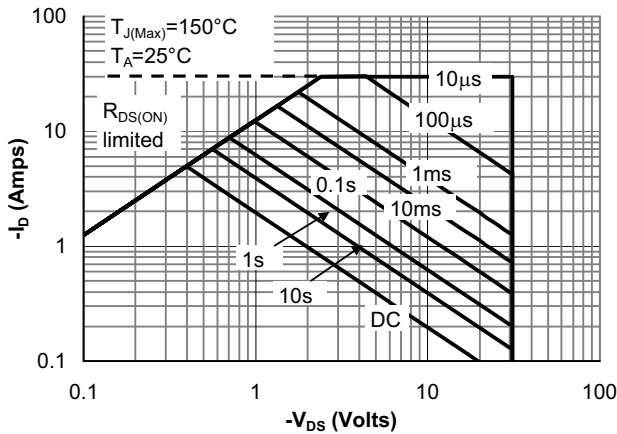
Typical Characteristics (Ta=25°C, unless otherwise noted)

Drain Current VS Drain-Source voltage

Drain Current vs ON Resistance

Gate-Source Voltage vs ON Resistance

Drain Current VS Gate-Source Voltage

Drain Current VS Source-Drain Current

On-Resistance vs. Junction



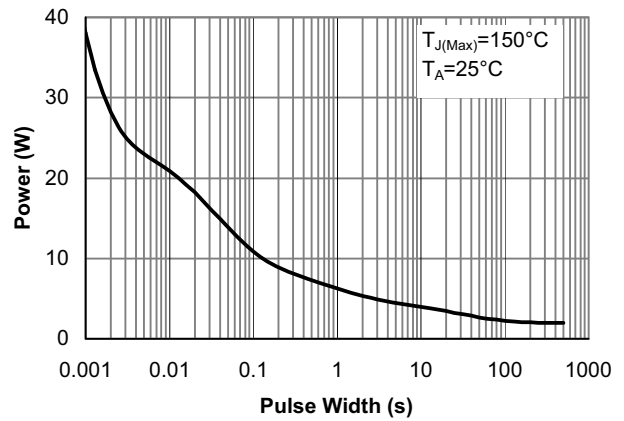
Gate Charge Characteristics



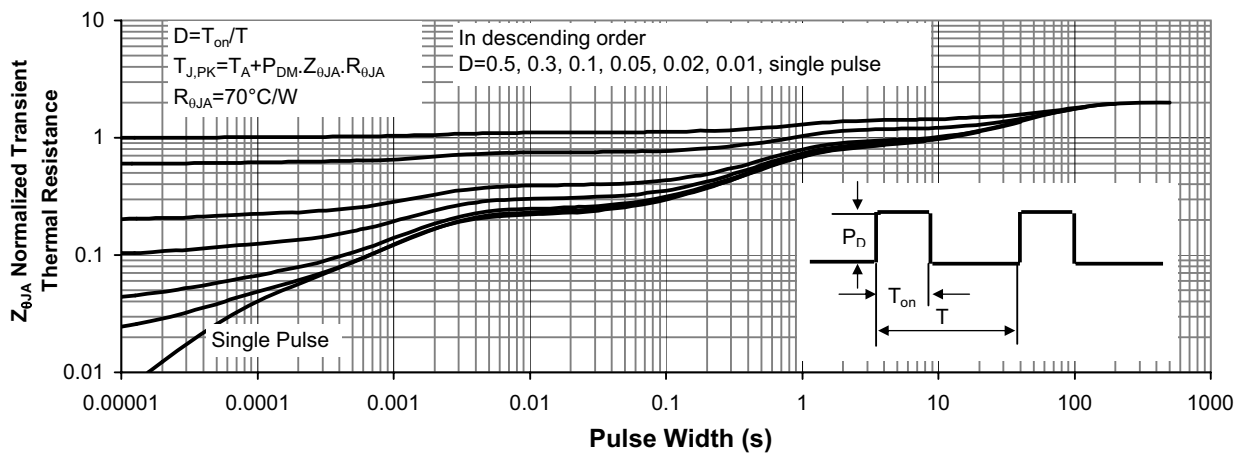
Capacitance Characteristics



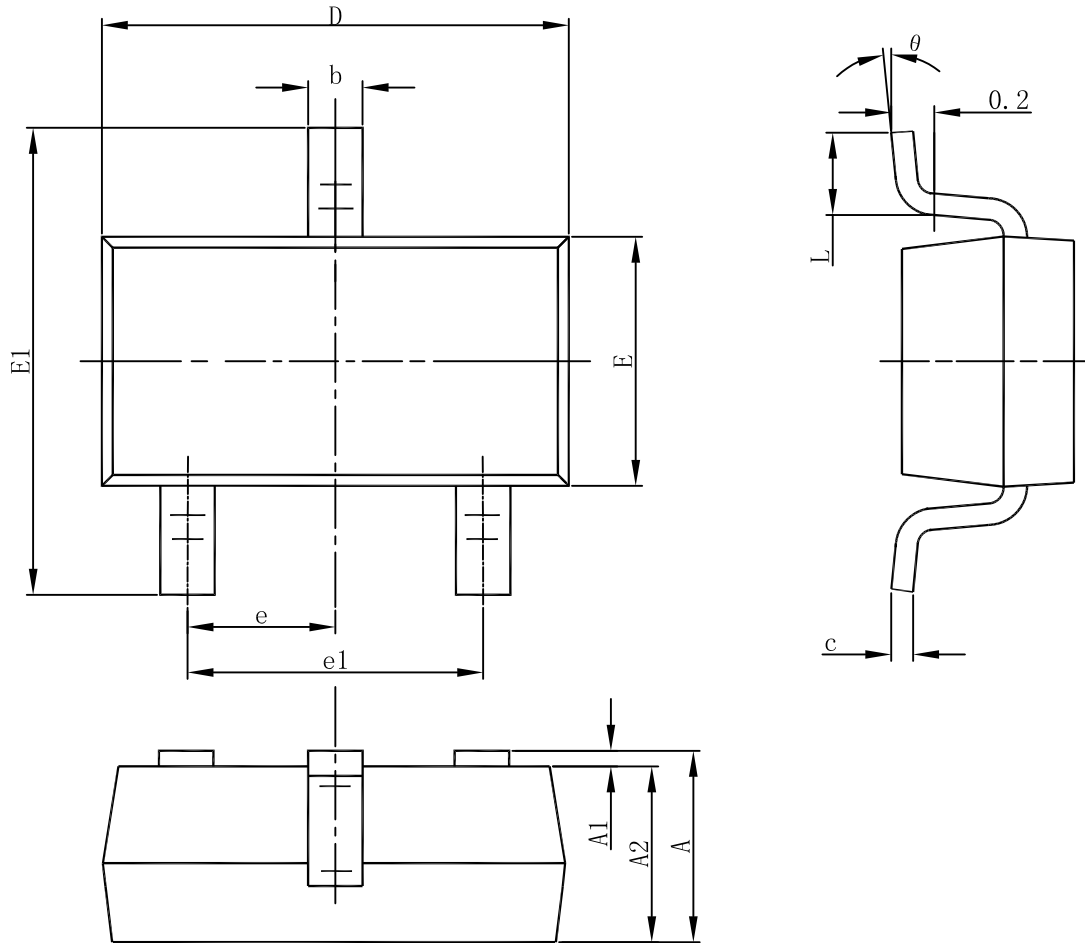
Maximum Forward Biased Safe Operating Area (Note E)



Single Pulse Power Rating Junction-to-Ambient (Note E)



Normalized Maximum Transient Thermal Impedance

Package outline dimensions
SOT-23-3L


| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 1.050 | 1.250 | 0.041 | 0.049 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 1.050 | 1.150 | 0.041 | 0.045 |
| b | 0.300 | 0.500 | 0.012 | 0.020 |
| c | 0.100 | 0.200 | 0.004 | 0.008 |
| D | 2.820 | 3.020 | 0.111 | 0.119 |
| E | 1.500 | 1.700 | 0.059 | 0.067 |
| E1 | 2.650 | 2.950 | 0.104 | 0.116 |
| e | 0.950(BSC) | | 0.037(BSC) | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 |
| L | 0.300 | 0.600 | 0.012 | 0.024 |
| θ | 0° | 8° | 0° | 8° |